



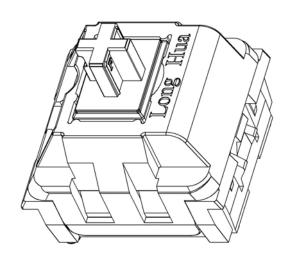


Document Number:

KH-PS1706-39

产品规格书

Product Specification



P/N:	-		Title:		
	CPG	151801D16	PG1518 Keyboard Switch		
Rev.	ECN	Release and Revision Description:	Prepared By /Date:	Checked By/Date:	Approved By/Date:
A		New releasing 初版发行	汤佳 2017-6-20	胡远锋 2017-6-20	David 2017-6-20



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1. Scope/范围:

This Product Specification covers the requirement of Mechanical Keyboard switch on product performance, test methods and quality assurance provisions.

本规格书内容涵盖机械键盘开关产品的要求,包括性能指标、测试方法及质量保证方面等。

2. Product Application/产品应用:

Mainly applied on computer keyboards, cash registers, industrial equipment and Man-Machine interface.

主要适用于电脑键盘,收银机、工业设备和人机界面。

3. Technology Parameters/技术参数

Ambient Humidity 工作湿度: 45~85% R.H.; Operating Temperature Range 使用温度范围: -10℃~+70℃;

Storage Temperature Range 保存温度范围: -20℃~+70℃;

Suggested storage period 贮存期限: about 6 months 最多 6 个月

Require the tin part on the switch terminals should keep good after storage guarantee date 要求贮存期后开关端子部分上锡仍然良好。

Normal Condition:

Ambient temperature 环境温度: 20±2℃

Relative humidity 相对湿度: 65%±5% R.H.; Air pressure 气压: 86~101KPa;

4. Ratings/额定性能要求

Rating 额定负荷: 12V AC/DC max.2V DC min.

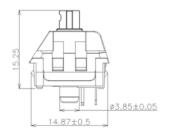
10mA AC/DC max.10 μ A DC min:

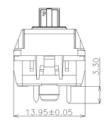
Insulation Resistance 绝缘电阻: ≥100MΩ/DC 500V;

Withstand Voltage 耐电压: 100V AC 1 Minute; Mechanical Life 机械寿命: 50,000,000 Cycles.

5. Profile Dimensions /外形尺寸









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6. Electrical Performance/电气性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求
6.1	Contact Resistance 接触电阻	Static load: (Operation force)x2, which is applied on the center of Switch stem. 静态负载: 动作力的 2 倍,施加在手柄中心. Measurement tool: Contact resistance Meter. 测量工具: 微电流接触电阻计(1KHz, 20mV,5~50mA) 在低电流(≤100mA)条件下测试. Measured at low current (100mA or less).	100mΩ Max 100mΩ以下
6.2	Insulation Resistance 绝缘电阻	Apply a Voltage of DC 500 V for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body. 输入 500V DC 电压 1 分钟,按如下接触方法测试: (1) 端子与端子之间. (2) 端子与外壳之间.	100MΩ Min 100 兆欧以上
6.3	Dielectric withstanding voltage 耐电压	Apply a Voltage of AC100 V (50~60Hz) for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body. 输入 100V AC 电压 1 分钟,按如下接触方法测试: (1) 端子与端子之间. (2) 端子与外壳之间.	No evidence of breakdown 无瞬断、击穿等破坏.
6.4	Bouncing 触点抖动	Operation speed: 3~4 times/s 操作速度: 每秒 3~4 次 Oscillo scope 示波器 Switch Bouncing Test Circuit 抖动测定回路.	Before Life cycle: On:5ms MAX,5 毫秒以下 Off: 5ms MAX,5 毫秒以下 After Life cycle: On:10ms MAX,10 毫秒以下 Off: 10ms MAX,10 毫秒以下



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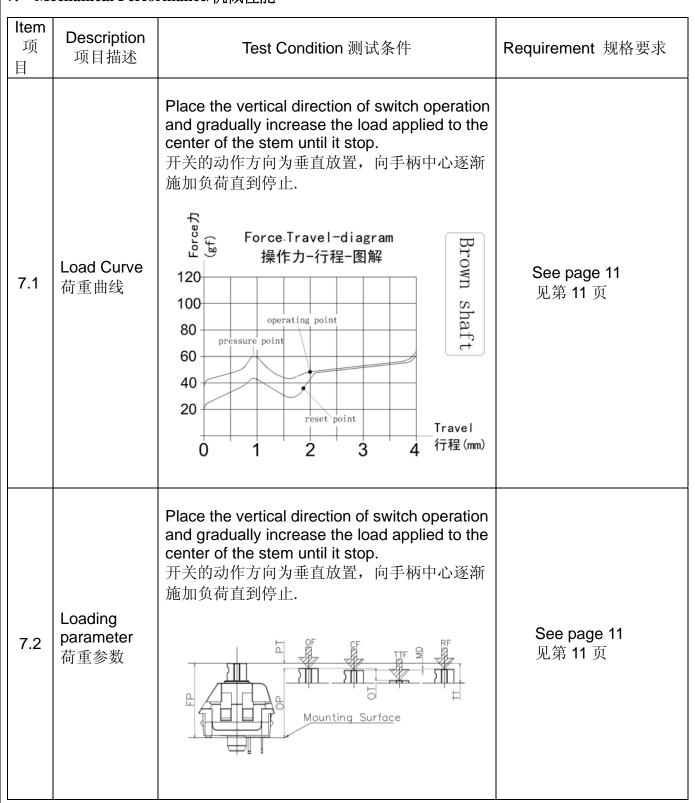
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7. Mechanical Performance/机械性能





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7.3	Static Strength 静止强度	A static load of 3kgf shall be applied in the direction of button operation for a period of 60 seconds. 在手柄动作方向施加 3kgf 的静负荷 60 秒, 然后测试参数.	No damag (Electrical) And mech 电气和机构) anical)	· .
7.4	Stem Pull Strength 手柄拉拔强 度	Break by a pull force applied opposite to the direction of stem operation. 在推柄动作方向反向垂直施加拉力, 使其破坏的程度.	5kgf N	⁄lin	
7.5	Shock 机械冲击	Measured by according to the below condition: (1) Acceleration: 80g 加速度 (2) Cycles of test:3 cycles each in 6 directions, for a total of 18 cycles. 试验次数:每个方向 3 次,6 个方向共 18 次.	Shall mee 7.2. 满足 6,7		·
7.6	Life Test 寿命测试	1) D.C.12V 10mA resistance load D.C 12V 10mA 电阻负荷 2) Operation speed: 5-6 times / s 动作速度: 5-6 次/ 秒 3) Push force: 150gf 按力: 150gf 5) Push travel: 4.0mm 按压行程: 4.0mm 6) Operation number: 50,000,000cycles 动作次数: 50,000,000 次	Contact re 1000 m Ω 接触电阻: Bouncing: 触点抖动: Operation Variation r 30% 操作力的多 值的±30%	Max 1000 毫欧 10ms M 10 毫秒以 force: ate within 变化范围在	ax 以下 土



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8. Environmental Performance/环境性能

Item	Description		1
项目	项目描述	Test Condition 测试条件	Requirement 规格要求
8.1	test 耐寒性	 (1) Temperature: -20±2℃ 温度: -20±2℃ (2) Duration of test: 48h 持续时间: 48 小时 (3) Take off a drop water 去掉水珠 (4) Standard conditions after test: 1h 试验后的放置条件: 1 小时 	Contact resistance: 200m Ω Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2 接触电阻 200m Ω以下 满足: No. 6.2 to 6.4 No. 7.1 to 7.2
8.2	Heat test 耐热性	 (1) Temperature: 70±2℃ 温度: 70±2℃ (2) Duration of test: 48h 持续时间: 48 小时 (3) Take off a drop water 去掉水珠 (4) Standard conditions after test: 1h 试验后的放置条件: 1 小时 	Contact resistance: 200m Ω Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2 接触电阻 200m Ω以下 满足: No. 6.2 to 6.4 No. 7.1 to 7.2
8.3	Temperature cycle 温度循环	(1) Test cycles: 5 cycles 试验周期: 5 个周期 (2) Standard condition after test:1h 试验后的放置条件: 1 小时 Temperature 温度	Contact resistance: 200m Ω Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2 接触电阻 200m Ω以下 满足: No. 6.2 to 6.4 No. 7.1 to 7.2
8.4	Soldering heat test 耐焊接热	Soldering area: T/2 of PWB thickness. (PWB: T=1.6mm) 焊接面积: 印刷基板的 1/2 厚度处 Soldering temperature: 260±5℃ Soldering time: 5±0.5s 焊接温度: 260±5℃ 焊接时间: 5±0.5 秒	Appearance: No abnormality. 外观无异常



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8.5	Solder ability 可焊性	1. Hand soldering 手工焊接: Please practice according to below condition: (1) Soldering Temperature: 350±5℃ 焊接温度: 350±5℃ (2) Continual soldering time: 3±0.5s 连续焊接时间: 3±0.5秒 (1) Capacity of soldering iron: ≤20w 电烙铁功率: 20 瓦以下 2. Automatic Reflow soldering 自动焊接: For the product of T/H according to below condition:			At least 9 area of in portion sh by solder 侵焊面积	nmersed nall be co	vered	
8.6	Humidity test 耐湿性	 (1) Temperature: 60±2℃ 温度: 60±2℃ (2) relative humidity: 90~95% R.H. 相对湿度:90~95% R.H. (3) Duration of test: 48h 持续时间: 48 小时 (4) Take off a drop water 去掉水珠 (5) Standard conditions after test: 1h 			Contact r 200m Ω Shall med No. 6.2 to No. 7.1 to 接触电阻 满足: No. 6.2 to No. 7.1 to	Max et: 0 6.4 0 7.2 200m Ω		
8.7	Salt Spray 盐雾测试	试验后的放置条件: 1 小时 Apply the following environment to test: 根据下列条件进行测试: (1) Temperature: 35±5℃ 温度: 35±5℃; (2) Salt water density: 5±1% 盐水浓度: 5±1%; (3) Duration: 12hours 持续时间: 12 小时; (4) After test, the salt deposit shall be removed by running water. 实验后将盐沉积物用水冲掉			Appearar No corros crack, no naked. 外观: 无原 无裸露基 Contact F 200 m Ω 接触电阻	sion spot, base pla 雾蚀点,无 材. Resistanc Max	te 裂纹, e:	



8.8

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Withstand K₂S 硫化测试	Apply the following e 根据下列条件进行测 (1) Temperature: 35 (2)K ₂ S Density: 2%; 硫化钾浓度: 2% (3) Duration: 2 minut 持续时间: 2分钟	试 ±5℃温度: 35 ±: te.		crack, no naked. 外观: 无原 无裸露基 Contact F 1000 m Ω	sion spot, base plat 雾蚀点,无 材. Resistance	ie 裂纹, e:



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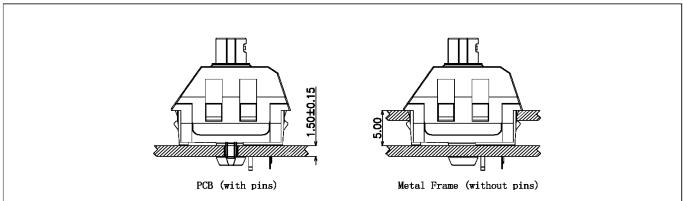
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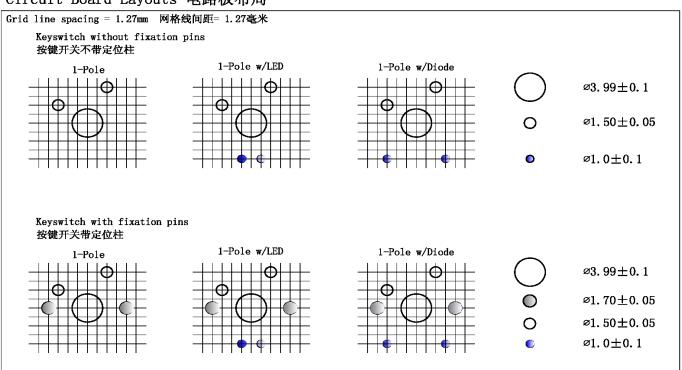
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9. Recommended PCB Layout 推荐的 PCB 安装焊盘规格

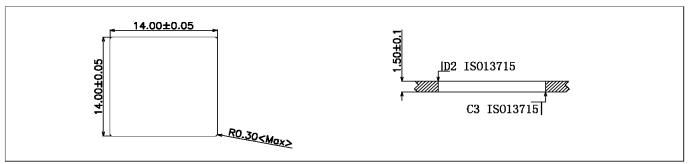
Mounting Options 安装选项



Circuit Board Layouts 电路板布局



Metal Frame Cutout Dimensions





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10. Loading Parameter (FP/OP/PT/OF/OT /MD/RF/TT) Specification 荷重参数规格:

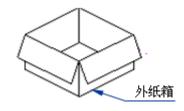
Parameter	Unit	Specification	Remark
FP(自由行程)	mm	15.25 ± 0.2	
OP(动作行程)	mm	13.35 ± 0.7	
PT(导通行程)	mm	1.9 ± 0.5	
OF(操作力)	gf	50±10	
OT(过行程)	mm	1.2	Min
MD(差动行程)	mm	0.6	Max
RF(回弹力)	gf	15	Min
TT(总行程)	mm	$4.0_{-0.4}^{+0}$	

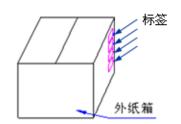
11. Packaging 包装

Packaging type: Tray, 1000Pcs/Tray, 4000Pcs/Carton.

包装方式: Tray 盘,1000Pcs/盘,4000Pcs/箱.







12.Precaution 注意事项

12.1 Initial Soldering Condition {文件本门				
ITEM	CONDITION			
项目	条件			
Preheat temperature	110℃ Max (Ambient temperature of soldering surface of P.W.B)			
预热温度	110℃以下(印刷基板焊锡面周围的温度)			
Preheat time 预热时间	60s, Max 60 秒以内			
Area of flux	1/2 Max of PWB Thickness			
助焊剂面积	印刷基板厚度的 1/2 以内			
Temperature of solder	260±5℃			
焊锡温度	260±5℃			
Time of immersion	Within 5s			
浸焊时间	5 秒以内			
Number of soldering	2time Max (But should down heat of the first soldering)			
焊接次数	2 次以内			
Printed wiring board	Single side copper-clad laminates			
印刷基板	单面铜箔			

- (1) After switches were soldered, please be careful not to clean switches with solvent 开关浸焊后,注意不要用溶剂清洗.
- (2) Under the condition of using soldering iron, soldering temperature shall be 350 ℃ max within 3 sec.



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在使用铬铁的情况下,焊锡温度应在350℃以下,焊接时间3秒以内.

12.2 Notes 注意点

- (1) Please be cautious not to give excessive static load or shock to switches.
 - 注意不要施加超负荷的压力或晃动开关.
 - (2) Please be careful not to stack up P. W. B. after switches were soldered.
 - 开关焊接以后,印刷基板注意不要叠放.
 - (3) Preservation under high temperature and high humidity or corrosive gas should be avoided Especially. When you need to preserve for a long period, do not open the carton. 保管时尤其应注意避开高湿高温和有腐蚀性气体的环境.如需长时间保存,请不要打开包装箱.
 - (4) Products meet the ROHS & REACH environmental management substances control standards 产品满足 ROHS & REACH 环境管理物质管制标准